



D. Thin Film Process Technology 분과

2021년 1월 27일(수), 13:00-14:30 / 채널 A

[WA3-D] Thin Film Process II

좌장: 엄태용 박사 (KRICT), 전우진 교수 (경희대학교)

<p>WA3-D-1 13:00-13:15</p>	<p>Advanced Atomic Layer Deposition of Metal Oxide Films with Discrete Feeding Method Jae Chan Park¹, Sang Gil Lee², Seung Jo Yoo², Ji Hyeon Lee², Jae Hyuck Jang², Woo-Hee Kim¹, and Tae Joo Park¹ ¹Department of Materials Science and Chemical Engineering, Hanyang University, ²Center for Research Equipment, KBSI</p>
<p>WA3-D-2 13:15-13:30</p>	<p>Atomic Layer Deposition of Titanium Dioxide Thin Films Using Cp*Ti(OMe)₃ as a Precursor Hong Keun Chung^{1,2}, Tae Joo Park², and Seong Keun Kim¹ ¹Electronic Materials Research Center, KIST, ²Department of Materials Science and Chemical Engineering, Hanyang University</p>
<p>WA3-D-3 13:30-13:45</p>	<p>Integrating SiO₂ Selective Deposition Process to Atomic Layer Etching of Ru for Self-aligned Nanofabrication Sumaira Yasmeen, Byeongguk Ko, Bon Wook Gu, and Han-Bo-Ram Lee Incheon National University</p>
<p>WA3-D-4 13:45-14:00</p>	<p>Atomic Layer Deposition of Tin Selenide (Sn_xSe_{1-x}) Thin Films Using Sn^{IV}(NMe₂)₄ and Se(SiMe₃)₂ with NH₃ Co-reagent Jeong Woo Jeon^{1,2}, Chanyoung Yoo^{1,2}, Woohyun Kim^{1,2}, Wonho Choi^{1,2}, Byongwoo Park^{1,2}, Eui-sang Park^{1,2}, Manick Ha^{1,2}, Yoon Kyeong Lee³, and Cheol Seong Hwang^{1,2} ¹Department of Materials Science and Engineering, Seoul National University, ²Inter-University Semiconductor Research Center, Seoul National University, ³Division of Advanced Materials Engineering, Jeonbuk National University</p>
<p>WA3-D-5 14:00-14:15</p>	<p>Selective Wet Etching of Si Versus Si_{1-x}Ge_x in Single- and Multi-Layer with TMAH Etchant 최용준, 변대섭, 조충희, 이기석, 윤동민, 고대홍 연세대학교 신소재공학과</p>
<p>WA3-D-6 14:15-14:30</p>	<p>철회</p>